

## **Thyristor**

1200 V

57 A

 $V_{\mathsf{T}}$ 1.2 V

## Single Thyristor

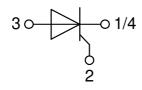
Part number

#### MCO50-12io1



Backside: isolated





#### Features / Advantages:

- Thyristor for line frequency
- Planar passivated chip
- Long-term stability

#### **Applications:**

- Line rectifying 50/60 Hz
- Softstart AC motor control
- DC Motor control
- Power converter AC power control
- Lighting and temperature control

Package: SOT-227B (minibloc)

- Isolation Voltage: 3000 V~
- Industry standard outline
- RoHS compliant
- Epoxy meets UL 94V-0
- Base plate: Copper
- internally DCB isolated Advanced power cycling

#### **Disclaimer Notice**

Information furnished is believed to be accurate and reliable. However, users should independently evaluate the suitability of and test each product selected for their own applications. Littelfuse products are not designed for, and may not be used in, all applications. Read complete Disclaimer Notice at www.littelfuse.com/disclaimer-electronics.



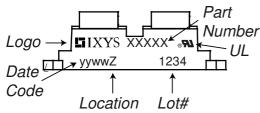
B.C.W.	O a seller a se			l .	<b>S</b>	
		T 0500	min.	typ.		Un
<u> </u>						i !
·						
reverse current, drain current						μ
						m
forward voltage drop	•	$T_{VJ} = 25^{\circ}C$			1.27	¦ '
	-				1.53	'
	$I_T = 50 \text{ A}$	$T_{VJ} = 125$ °C			1.20	,
	$I_{T} = 100 \text{ A}$				1.50	!
average forward current	$T_C = 80^{\circ}C$	$T_{VJ} = 150$ °C			57	
RMS forward current	180° sine				90	1
threshold voltage		$T_{VJ} = 150$ °C			0.88	ļ ,
slope resistance \( \) for power lo	ess calculation only				6	m۵
thermal resistance junction to cas	e				0.72	K/V
thermal resistance case to heatsin	nk			0.2		K/V
total power dissipation		$T_{\rm C} = 25^{\circ}{\rm C}$			170	٧
· · · · · · · · · · · · · · · · · · ·	t = 10 ms: (50 Hz), sine					,
<u> </u>	. ,	••			800	
	· · · · · · · · · · · · · · · · · · ·					
	. ,	**				
value for fusing						
value for rushing	·					kA <sup>2</sup>
						1
	. ,					į
iunation canacitana				20	1.93	
				32	10	p
max. gate power dissipation	•	$I_{\rm C} = 150^{\circ}{\rm C}$				۷
	t <sub>P</sub> = 300 μs					۷
						٧
critical rate of rise of current		•			100	A/μ
						!
	$I_G = 0.3 \text{ A}; V = \frac{2}{3} V_{DRM}$ no	on-repet., $I_T = 50 \text{ A}$			500	A/μ:
critical rate of rise of voltage	$V = \frac{2}{3} V_{DRM}$	$T_{VJ} = 150$ °C			1000	V/µ
	R <sub>GK</sub> = ∞; method 1 (linear volta	ge rise)				i ! !
gate trigger voltage	V <sub>D</sub> = 6 V	$T_{VJ} = 25^{\circ}C$			1.4	١
		$T_{VJ} = -40$ °C			1.6	١
gate trigger current	$V_D = 6 V$	$T_{VJ} = 25^{\circ}C$			80	m/
		$T_{VJ} = -40$ °C			200	m/
gate non-trigger voltage	$V_D = \frac{2}{3} V_{DBM}$				0.2	١
gate non-trigger current	5 5	-			5	m/
	t <sub>s</sub> = 10 us	T <sub>v1</sub> = 25°C				m
<b>U</b>	•				.50	,
holding current					100	m
						i
gate controlled delay tillle						μ
		150		1		
turn-off time	$V_R = 100 \text{ V}; I_T = 50 \text{A}; V = \frac{2}{3}$					μ
	max. repetitive reverse/forward black reverse current, drain current forward voltage drop  average forward current threshold voltage slope resistance junction to case thermal resistance case to heatsing total power dissipation max. forward surge current value for fusing  junction capacitance max. gate power dissipation critical rate of rise of current critical rate of rise of voltage gate trigger voltage gate trigger current	$\begin{array}{llllllllllllllllllllllllllllllllllll$	$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	$ \begin{array}{llllllllllllllllllllllllllllllllllll$	$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	max. non-repetitive reverse/forward blocking voltage $T_{v,i} = 25^{\circ}C$ 1300           max. repetitive reverse/forward blocking voltage $T_{v,i} = 25^{\circ}C$ 1200           reverse current, drain current $V_{N_{10}} = 1200 \text{ V}$ $T_{v,i} = 126^{\circ}C$ 50           I converse current, drain current $V_{N_{10}} = 1200 \text{ V}$ $T_{v,i} = 125^{\circ}C$ 30           I converse current, drain current $T_{i} = 50 \text{ A}$ $T_{v,i} = 125^{\circ}C$ 1.27           I reverse forward current $T_{i} = 50 \text{ A}$ $T_{v,i} = 125^{\circ}C$ 1.20           I reverse forward current $T_{i} = 80^{\circ}C$ $T_{v,i} = 150^{\circ}C$ 57           RMS forward current $T_{i} = 80^{\circ}C$ $T_{v,i} = 150^{\circ}C$ 57           RMS forward current $T_{i} = 80^{\circ}C$ $T_{v,i} = 150^{\circ}C$ 0.88           slope resistance         for power loss calculation only $T_{v,i} = 150^{\circ}C$ 0.88           thermal resistance for lost on the staink $T_{v,i} = 150^{\circ}C$ 0.88           total power dissipation $T_{i} = 25^{\circ}C$ 170           max. forward surge current $t = 10^{\circ}$ ms; (50 Hz), sine $T_{v,i} = 150^{\circ}C$ 740           tack power dissipation



Package	Package SOT-227B (minibloc)			Ratings				
Symbol	Definition	Conditions			min.	typ.	max.	Unit
I <sub>RMS</sub>	RMS current	per terminal 10					150	Α
T <sub>VJ</sub>	virtual junction temperatur	re			-40		150	°C
T <sub>op</sub>	operation temperature				-40		125	°C
T <sub>stg</sub>	storage temperature						150	°C
Weight						30		g
M <sub>D</sub>	mounting torque				1.1		1.5	Nm
$\mathbf{M}_{_{T}}$	terminal torque				1.1		1.5	Nm
d <sub>Spp/App</sub>	oroonaga diatanaa an aurt	face Latriking diatance through air	terminal to terminal	10.5	3.2			mm
$d_{Spb/Apb}$	creepage distance on sun	face   striking distance through air	terminal to backside		6.8			mm
V <sub>ISOL</sub>	isolation voltage	t = 1 second			3000			٧
1002	t = 1 minu		50/60 Hz, RMS; lisoL ≤ 1 mA					٧

<sup>1)</sup>  $I_{\text{hus}}$  is typically limited by the pin-to-chip resistance (1); or by the current capability of the chip (2). In case of (1) and a product with multiple pins for one chip-potential, the current capability can be increased by connecting the pins as one contact.



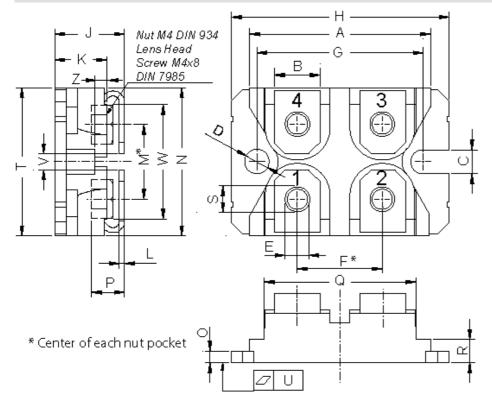


Ordering	Ordering Number	Marking on Product	Delivery Mode	Quantity	Code No.
Standard	MCO50-12io1	MCO50-12io1	Tube	10	500555

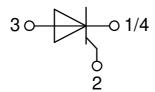
Equiva	lent Circuits for	Simulation	* on die level	$T_{VJ} = 150$ °C
$I \rightarrow V_0$	)— <u>R</u> o	Thyristor		
V <sub>0 max</sub>	threshold voltage	0.88		V
R <sub>0 max</sub>	slope resistance *	4.1		mΩ



### Outlines SOT-227B (minibloc)



Dim.	Millir	neter	Inches			
DIM.	min max		min	max		
Α	31.50	31.88	1.240	1.255		
В	7.80	8.20	0.307	0.323		
С	4.09	4.29	0.161	0.169		
D	4.09	4.29	0.161	0.169		
Е	4.09	4.29	0.161	0.169		
F	14.91	15.11	0.587	0.595		
G	30.12	30.30	1.186	1.193		
Н	37.80	38.23	1.488	1.505		
J	11.68	12.22	0.460	0.481		
K	8.92	9.60	0.351	0.378		
L	0.74	0.84	0.029	0.033		
M	12.50	13.10	0.492	0.516		
N	25.15	25.42	0.990	1.001		
0	1.95	2.13	0.077	0.084		
Р	4.95	6.20	0.195	0.244		
Q	26.54	26.90	1.045	1.059		
R	3.94	4.42	0.155	0.167		
S	4.55	4.85	0.179	0.191		
Т	24.59	25.25	0.968	0.994		
U	-0.05	0.10	-0.002	0.004		
V	3.20	5.50	0.126	0.217		
W	19.81	21.08	0.780	0.830		
Ζ	2.50	2.70	0.098	0.106		





#### **Thyristor**

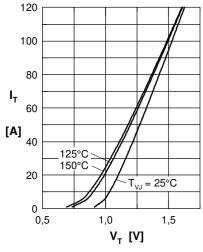


Fig. 1 Forward characteristics

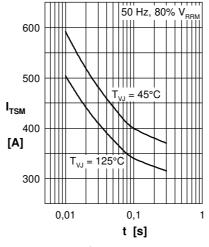


Fig. 2 Surge overload current

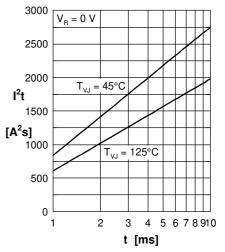


Fig. 3 I<sup>2</sup>t versus time (1-10 ms)

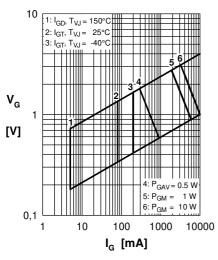


Fig. 4 Gate trigger characteristics

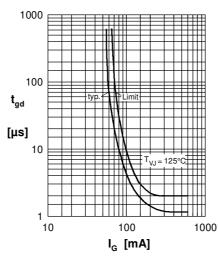


Fig. 5 Gate controlled delay time

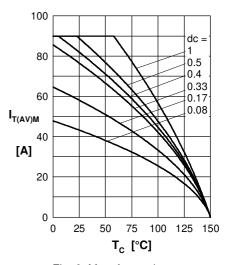


Fig. 6 Max. forward current at case temperature

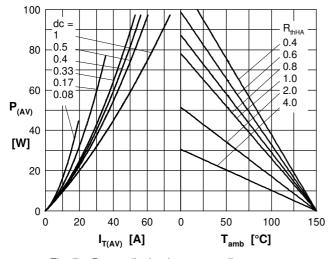


Fig. 7a Power dissipation versus direct output current Fig. 7b and ambient temperature

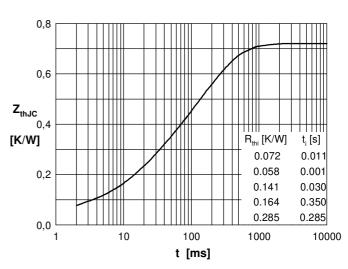


Fig. 8 Transient thermal impedance junction to case

# **X-ON Electronics**

Largest Supplier of Electrical and Electronic Components

Click to view similar products for Discrete Semiconductor Modules category:

Click to view products by IXYS manufacturer:

Other Similar products are found below:

<u>M252511FV</u> <u>DD2</u>	60N12K-A	DD380N16A	DD89N1600K-	$\underline{A}$ $\underline{APT2X21D0}$	C60J <u>APT58M</u>	80J B522F-2-Y	YEC MSTC90-1	<u>16</u> <u>25.163.0653.1</u>
25.163.2453.0 25.3	163.4253.0	25.190.2053.0	25.194.3453.0	25.320.4853.1	25.320.5253.1	25.326.3253.1	25.326.3553.1	25.330.1653.1
25.330.4753.1 25.3	330.5253.1	25.334.3253.1	25.334.3353.1	25.350.2053.0	25.352.4753.1	25.522.3253.0	<u>T483C</u> <u>T484C</u>	<u>T485F</u> <u>T485H</u>
T512F-YEB T513	F T514F T	554 <u>T612FSE</u>	25.161.3453.0	25.179.2253.0	25.194.3253.0	25.325.1253.1	25.326.4253.1	25.330.0953.1
25.332.4353.1 25.3	350.1653.0	25.350.2453.0	25.352.1453.0	25.352.1653.0	25.352.2453.0	25.352.5453.1	25.522.3353.0	25.602.4053.0
25.640.5053.0								